

## Electronic Patent Application Fee Transmittal

Application Number:	10510848			
Filing Date:	13-Oct-2004			
Title of Invention:	Diamond composite substrate and process for producing the same			
First Named Inventor/Applicant Name:	Kiichi Meguro			
Filer:	Brian K. Seidleck/Lana Marceron			
Attorney Docket Number:	50389-053			

Filed as Large Entity

### **U.S. National Stage under 35 USC 371 Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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**Basic Filing:**

**Pages:**

**Claims:**

**Miscellaneous-Filing:**

**Petition:**

**Patent-Appeals-and-Interference:**

Notice of appeal	1401	1	540	540
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**Post-Allowance-and-Post-Issuance:**

**Extension-of-Time:**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1650</b>